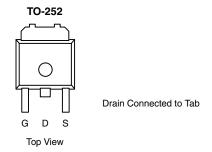




N-Channel 20 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a			
20	0.0060 at V _{GS} = 10 V	26			
20	0.0095 at V _{GS} = 4.5 V	21			



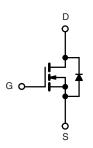
Ordering Information: SUD50N02-06P-E3 (Lead (Pb) free)

FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized for High Efficiency
- 100 % R_q Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Synchronous Buck DC/DC Conversion
 - Desktop
 - Server



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage		V _{DS}	20	V		
Gate-Source Voltage		V _{GS}	± 20			
Outline Print Outline	T _A = 25 °C	I-	26 ^a			
Continuous Drain Current ^a	T _C = 25 °C	l _D	50 ^b			
Pulsed Drain Current	I _{DM}	100	Α			
Continuous Source Current (Diode Conduction) ^a	I _S	26				
Avalanche Current	L = 0.1 mH	I _{AS}	45			
Single Pulse Avalanche Energy	L = 0.1 IIII1	E _{AS}	101	mJ		
Maximum Power Dissipation	T _A = 25 °C	P _D	6.8 ^a	w		
Maximum Fower Dissipation	T _C = 25 °C	1 ' ^D	65	7 "		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Marrian con location to Ambient	t ≤ 10 s	R _{thJA}	18	22			
Maximum Junction-to-Ambient ^a	Steady State	' 'thJA	40	50	°C/W		
Maximum Junction-to-Case	•	R _{thJC}	1.9	2.3			

- a. Surface mounted on FR4 board, $t \le 10 \text{ s.}$
- b. Limited by package.

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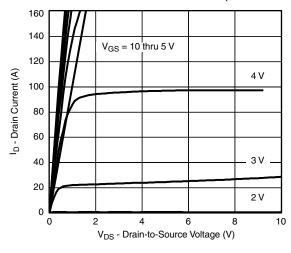
Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static				•	l L		
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	20			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.8		3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zoro Coto Voltogo Drain Current	l	V _{DS} = 20 V, V _{GS} = 0 V			1	1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50	μΑ	
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
		V _{GS} = 10 V, I _D = 20 A		0.0046	0.006	Ω	
Drain-Source On-State Resistance ^b	r _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125 ^{\circ}\text{C}$			0.0084		
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0073	0.0095		
Forward Transconductance ^b	g _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 20 \text{ A}$	15			S	
Dynamic ^a							
Input Capacitance	C _{iss}			2550		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 10 \text{ V}, f = 1 \text{ MHz}$		900			
Reverse Transfer Capacitance	C _{rss}			415			
Total Gate Charge ^c	Q_g			19	30		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 50 \text{ A}$		7.5		nC	
Gate-Drain Charge ^c	Q_{gd}			6			
Gate Resistance	R_g		0.5	1.5	2.4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			11	20		
Rise Time ^c	t _r	$V_{DD} = 10 \text{ V}, R_{L} = 0.2 \Omega$		10	15	ne	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		24	35	ns -	
Fall Time ^c	t _f			9	15		
Source-Drain Diode Ratings and Cha	racteristic (T	C = 25 °C)					
Pulsed Current	I _{SM}				100	Α	
Diode Forward Voltage ^b	V_{SD}	I _F = 50 A, V _{GS} = 0 V		1.2	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	$I_{\rm F} = 50 \text{ A}, dI/dt = 100 A/\mu s$		35	70	ns	

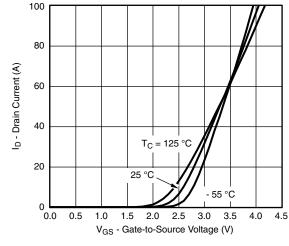
Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C unless noted)

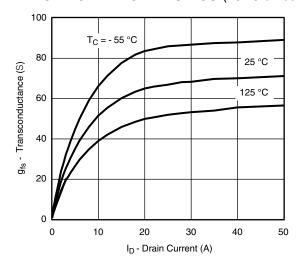




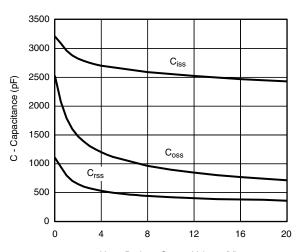
Output Characteristics Transfer Characteristics



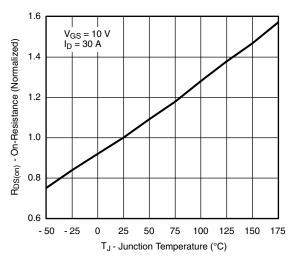
TYPICAL CHARACTERISTICS (25 °C unless noted)



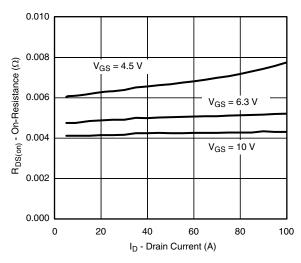
Transconductance



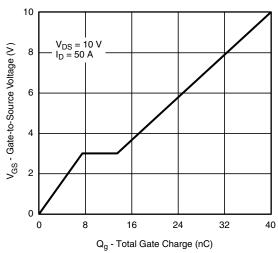
V_{DS} - Drain-to-Source Voltage (V) Capacitance



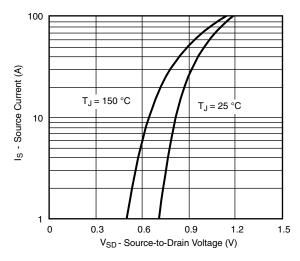
On-Resistance vs. Junction Temperature



On-Resistance vs. Drain Current



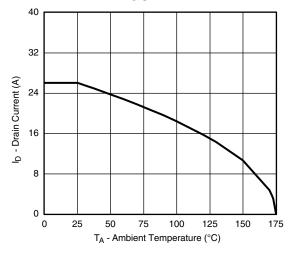
Gate Charge

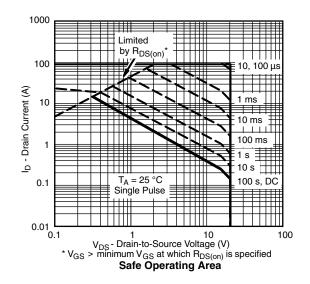


Source-Drain Diode Forward Voltage

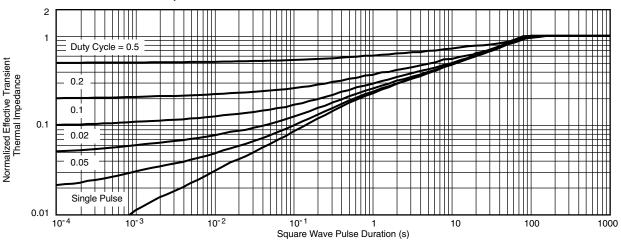
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THERMAL RATINGS

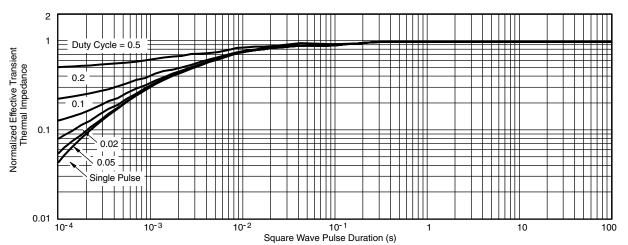






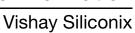






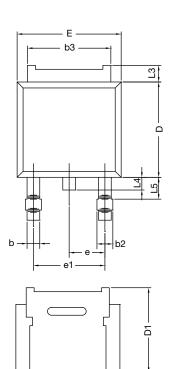
Normalized Thermal Transient Impedance, Junction-to-Case

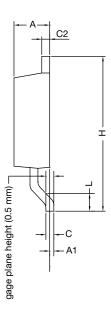
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71931.





TO-252AA Case Outline





	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
e	2.28 BSC		0.090 BSC		
e1	4.56	BSC	0.180	BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16					

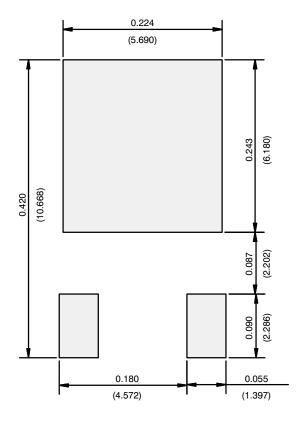
DWG: 5347

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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